

1W Yellow High Power LED Technical Data Sheet

Part No.: LL-HP60MUYC



Features:

- \diamond Very long operating life (up to100k hours).
- \diamond Available in white, green, blue, red, yellow.
- \diamond More energy efficient than incandescent and most halogen lamps.
- $\diamond \mathsf{Low}$ voltage DC operated.
- \diamond Cool beam, safe to the touch.
- \Diamond Instant light (less than 100 ns).
- $\diamond \mbox{The product itself will remain within RoHS compliant Version.}$

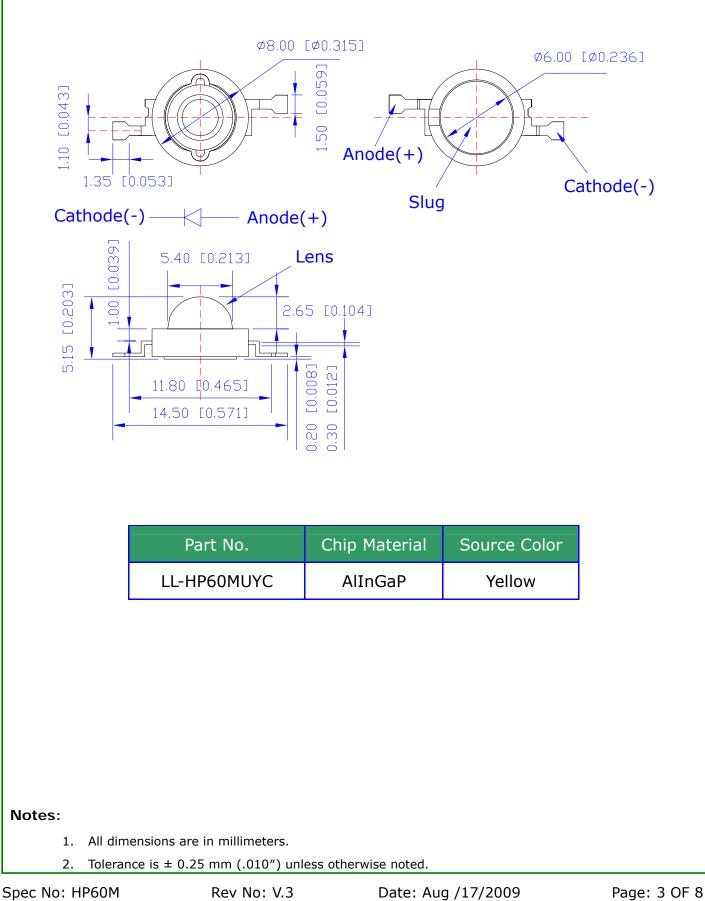
Applications:

- ◇Reading lights (car, bus, aircraft).
- \diamond Portable (flashlight, bicycle).
- $\\ \diamondsuit {\sf Mini_accent/Uplighters/Downlighters/Orientation.} \\$
- \diamond Bollards/Security/Garden.
- \Diamond Cove/Undershelf/Task.
- \diamond Automotive rear combination lamps.
- $\diamond {\sf Traffic}$ signaling/Beacons/ Rail crossing and Wayside.
- $\Diamond \mbox{Indoor/Outdoor}$ Commercial and Residential Architectural.
- \diamond Edge_lit signs (Exit, point of sale).
- \diamond LCD Backlights/Light Guides.









Approved: JoJo Checked: Wu Lucky Light Electronics Co., Ltd.



Absolute Maximum Ratings at Ta=25℃

| Parameters | Symbol | Rating | Units |
|---|----------------|-------------|---------|
| Forward Current | I F | 350 | mA |
| PeakPulseCurrent (tp≤100µs, Duty cycle=0.25) | I pulse | 700 | mA |
| Reverse Voltage | V R | 5 | V |
| LED Junction Temperature | Т ј | 125 | °C |
| Operating Temperature Range | T opr | -40 to +80 | °C |
| Storage Temperature Range | T stg | -40 to +100 | °C |
| Soldering Time at 260 $^{\circ}\!\!\!\!^{\circ}$ (Max.) | T sol | 5 | Seconds |

Notes:

- 1. Proper current derating must be observed to maintain junction temperature below the maximum.
- 2. LEDs are not designed to be driven in reserve bias.

Parameters Symbol Min. Typ. Max. Unit Test Condition Viewing Angle [1] **2θ**_{1/2} ___ 135 ___ Deg IF=350mA 2.0 2.2 V Forward Voltage [2] V_F 3.0 IF=350mA **Reverse Current** ____ \boldsymbol{I}_R ___ 10 μA $V_R = 5V$ Peak Emission Wavelength 593 IF=350mA **λ**p -----nm IF =350mA Dominant Wavelength λd 590 nm ------Spectrum Radiation Bandwidth 20 IF=350mA Δλ ___ ___ nm Luminous Flux 40 IF=350mA Фv 30 ___ Im

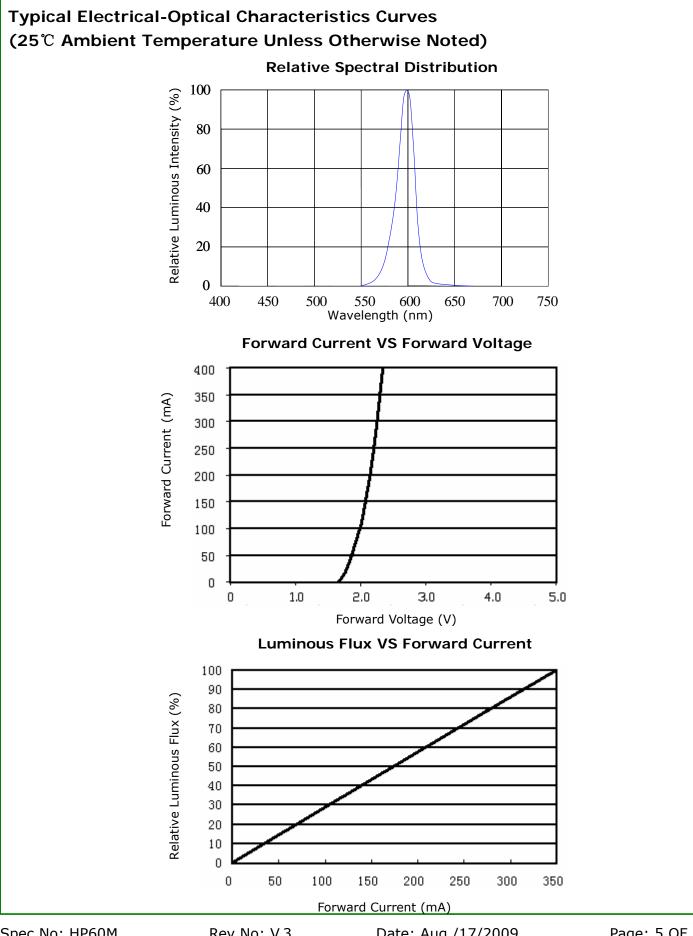
Electrical Optical Characteristics at Ta=25°C

Notes:

1. $2\theta 1/2$ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.

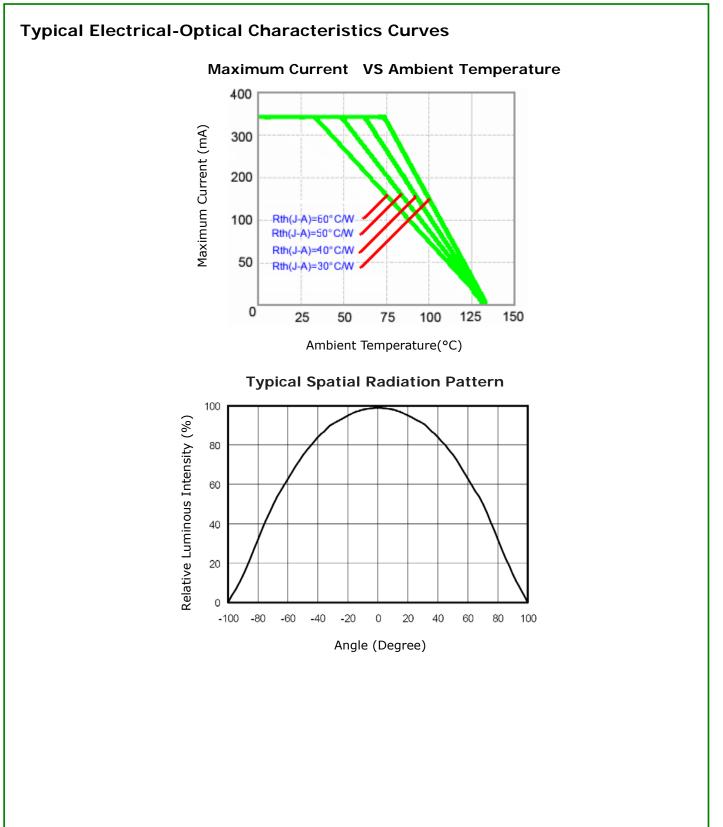
2. Forward Voltage measurement tolerance : $\pm 0.1V$





Date: Aug /17/2009 Page: 5 OF 8 Drawn: Yao http://www.luckylightled.com







Precautions For Use:

1. Over-current-proof

Though HP60M has conducted ESD protection mechanism, customer must not use the device in reverse and should apply resistors for extra protection. Otherwise slight voltage shift may cause enormou current change and burn out failure would happen.

2. Storage

- $(\ensuremath{\underline{1}})$ Do not open moisture proof bag before the products are ready to use.
- @ Before opening the package, the LEDs should be kept at 30 $^\circ\!\!\mathbb{C}$ or less and 90%RH or less.
- $\ensuremath{\textcircled{3}}$ The LEDs should be used within a year.
- 4 After opening the package, the LEDs should be kept at 30 $^\circ\!\!\mathrm{C}$ or less and 70%RH or less.
- 5 The LEDs should be used within 168 hours (7 days) after opening the package.

G If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storag time,

baking treatment should be performed using the following conditions.

O Pre-curing treatment: 60±5O for 24 hours.

3. Thermal Management

- ① Because HP60M LED is a high power dissipation device, special and sufficient consideration in thermal management design must be made to optimize the thermal performance.
- ② Heat sink design is implemented in the device for an additional thermal connection. Since the device is capable of SMT process, tin must be spread both heat sink and solder pads areas to dissipate the heat.
- ③ A high thermal conductivity substrate, such as Aluminum or Copper plate etc, must be applied for external thermal management. It is strongly recommended that the outer heat sink or PCB dimension per LED can not be less than 25 x 25 x 1 (L x W x H) mm. The materials for outer heat sink can be FR4 on Aluminum, MCPCB, or FPC on Aluminum.
- ④ Special thermal designs are also recommended to take in outer heat sink design, such as FR4 PCB on Aluminum with thermal vias or FPC on Aluminum with thermal conductive adhesive, etc.
- ⑤ Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LED lifetime will decrease critically.

4. Soldering Condition

- 1 3 Soldering should not be done more than two times.
- $\ensuremath{\textcircled{}}$ $\ensuremath{\textcircled{}}$ While soldering, do not put stress on the LEDs during heating.
- ③ After soldering, do not warp the circuit board.



5. Soldering Iron

① For prototype builds or small series production runs it is possible to place and solder the LED by hand.

@ It is recommended to hand solder the leads with a solder tip temperature of 280°C for less than 3 seconds within once

- in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal.
- $\ensuremath{\textcircled{3}}$ Be careful because the damage of the product is often started at the time of the hand solder.

6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible.

Sharp objects of all types should not be used to pierce the sealing compound.

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